



ABSTRACT

A production method of an electronic device comprising the steps of forming a stacked body by stacking green sheets ~~10~~asheets and electrode layers ~~12~~layers having a predetermined pattern and firing the stacked body. Before forming the stacked body, a blank pattern layer ~~24~~ having substantially the same thickness as that of the electrode layer is formed on a space portion of the electrode layer having a predetermined pattern. The electrode level difference absorbing print paste for forming the blank pattern layer ~~24~~layer includes at least ceramic powder and a binder resin, and a polymerization degree of the binder resin included in the electrode level difference absorbing print paste is made equal to or more than that of a binder resin included in slurry for forming the green sheet. The binder resin of the electrode level difference absorbing print paste ~~includes a~~ includes polyvinyl butyral resin, resin with a polymerization degree of the polyvinyl butyral resin is 1400 or more, a butyralation degree is ~~64 to 74 mol%~~ degree of 64 to 74 mol% and an acetalization ~~degree is~~ degree of 66 to 74 mol%.